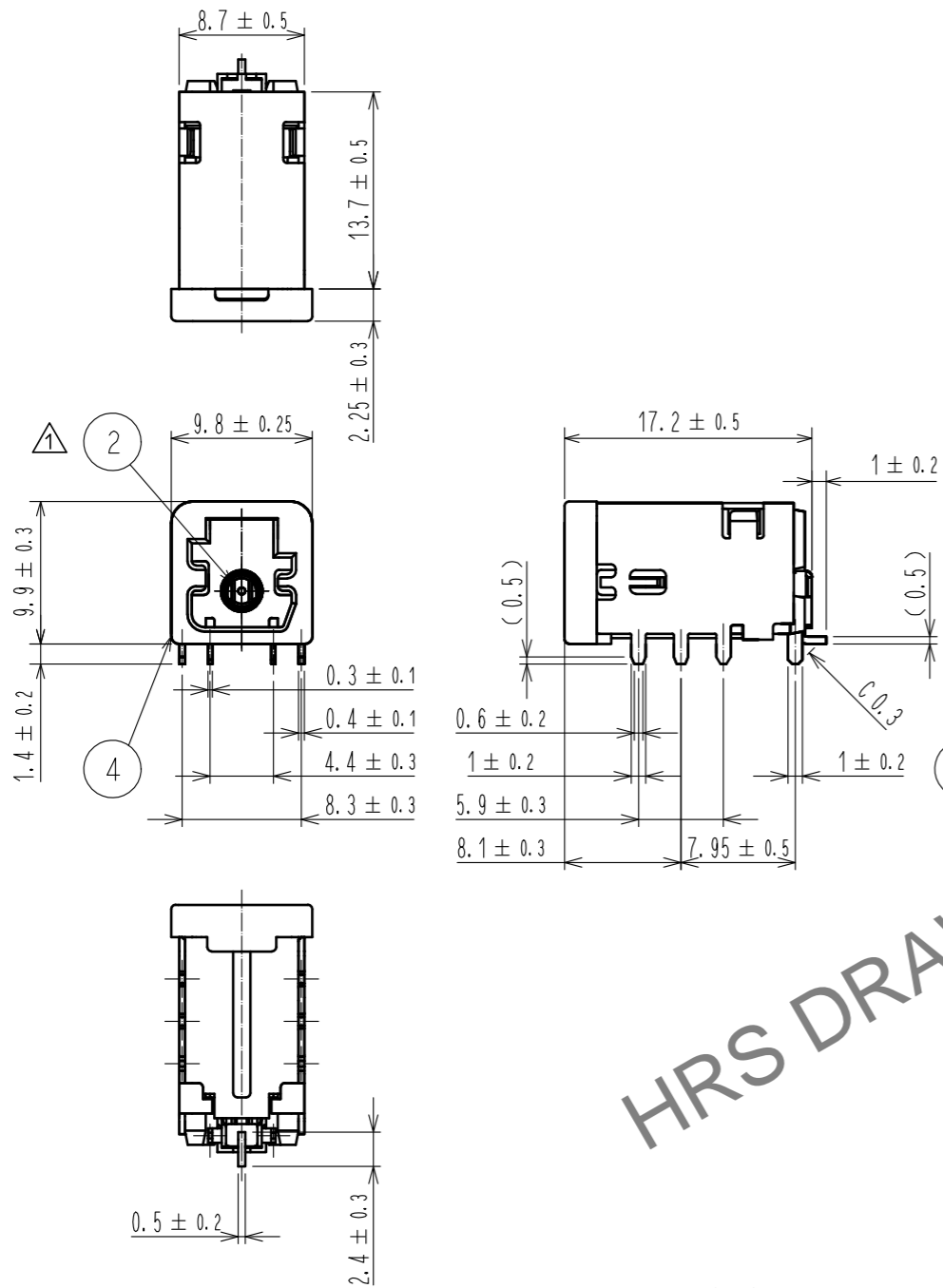
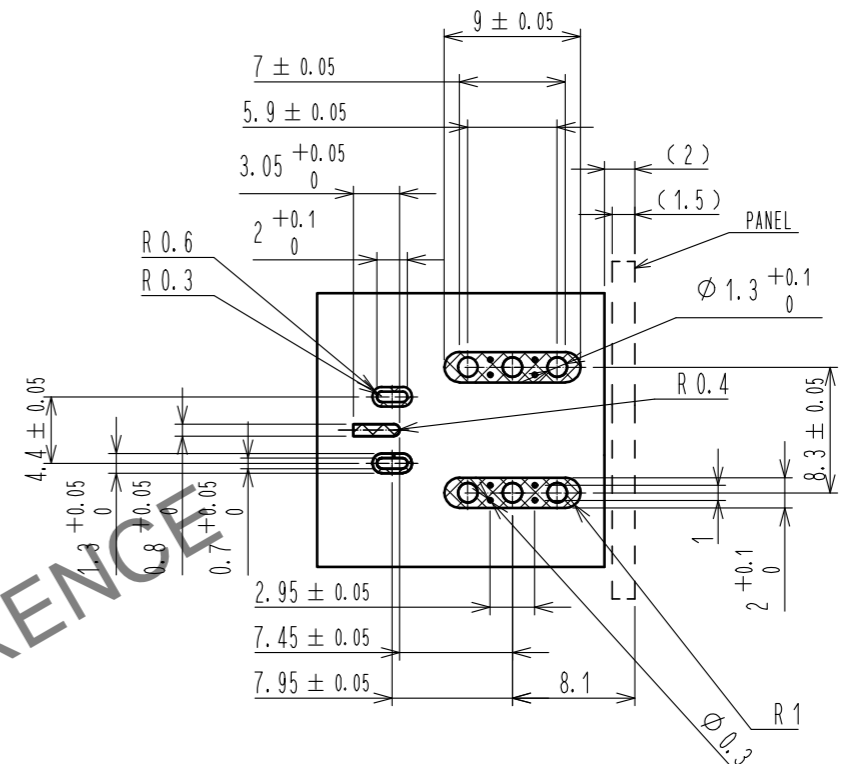


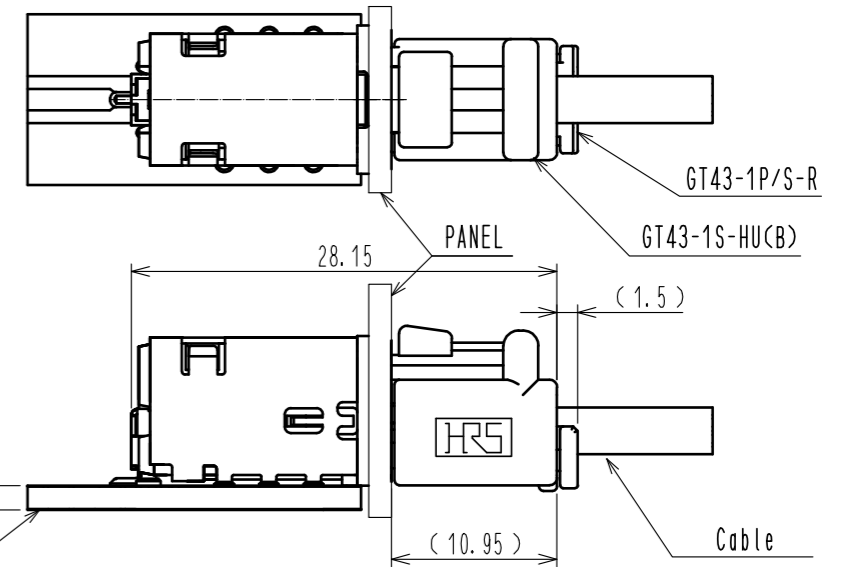
ELV. RoHS COMPLIANT



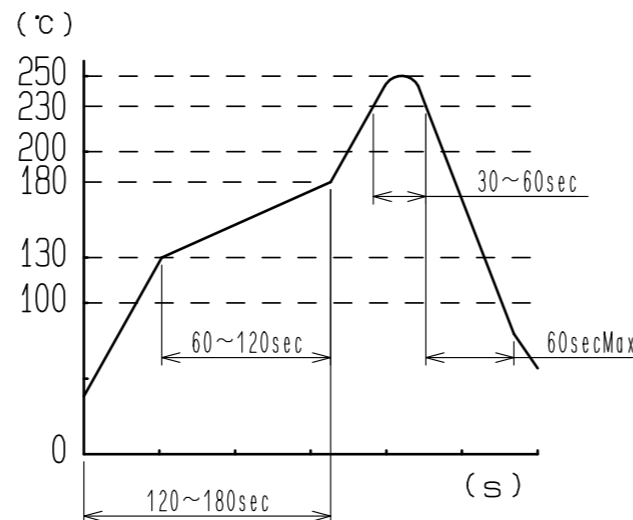
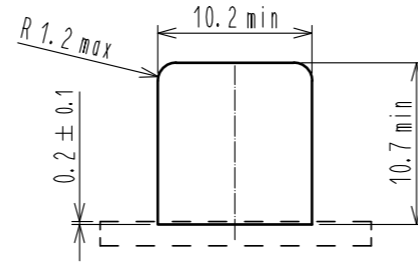
Recommended board pattern



Mated connectors



Recommended panel layout



NOTES

- Recommended reflow profile (See right graph)  
Cycle time : Twice  
Peak temperature : 250°C  
230°C MIN : 30~60s  
Preheating area : 130~180°C . 60~120s
- Hand solderling : 280~300°C 2s Max
- Recommended thickness of PCB : 1.6<sup>+0.2</sup>mm
- Recommended thickness of Solderling paste : 0.15mm

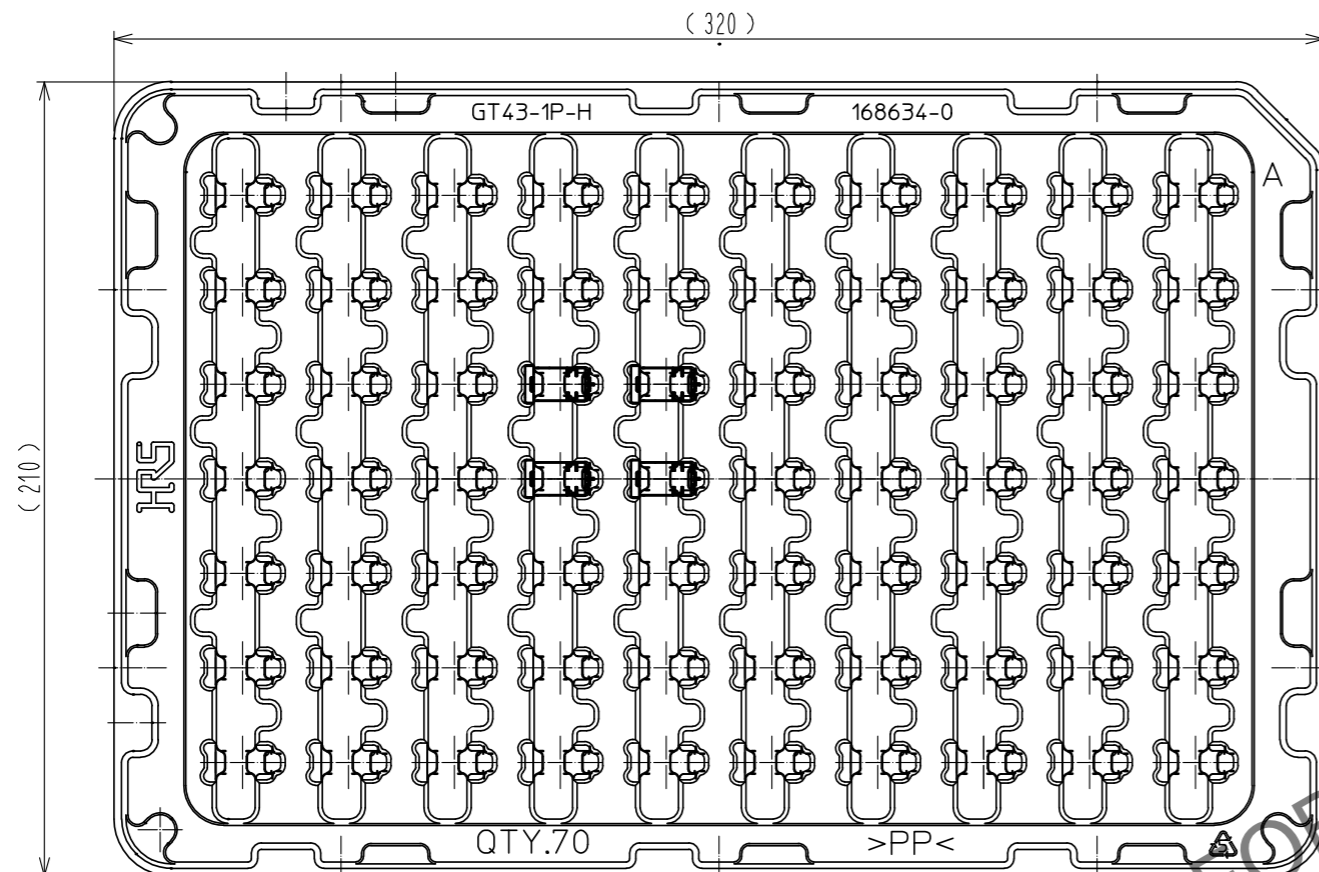
HRS DRAWING FOR REFERENCE

3	Brass	Tin plating				
2	PA	Black	5	Copper alloy	Tin plating	
1	Brass	Tin plating	4	PA	Green	
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS	
UNITS	mm	SCALE	2 : 1	COUNT	2	DESCRIPTION OF REVISIONS
						DESIGNED
						CHECKED
						DATE
APPROVED : KI. HIROKAWA			17.06.30	DRAWING NO.		
CHECKED : KI. HIROKAWA			17.06.30	PART NO.		
DESIGNED : NK. IKUTA			17.06.30	CODE NO.		
DRAWN : GYEONGMIN LEE			17.06.30	CL753-1013-0-00		
				EDC-377150-00-00		
				GT43-1P-H(B)		
				1/2		

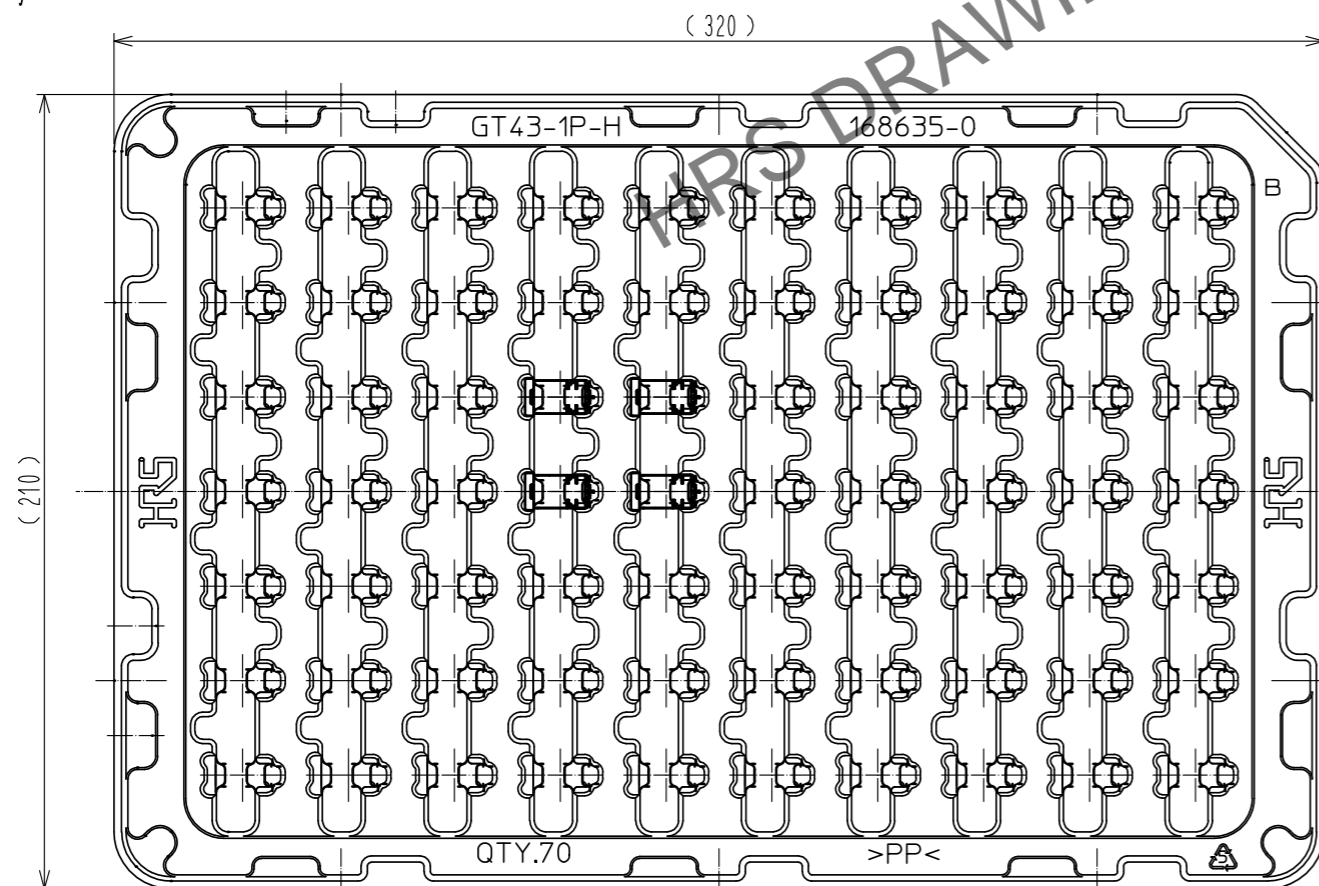
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tray A(1:2)

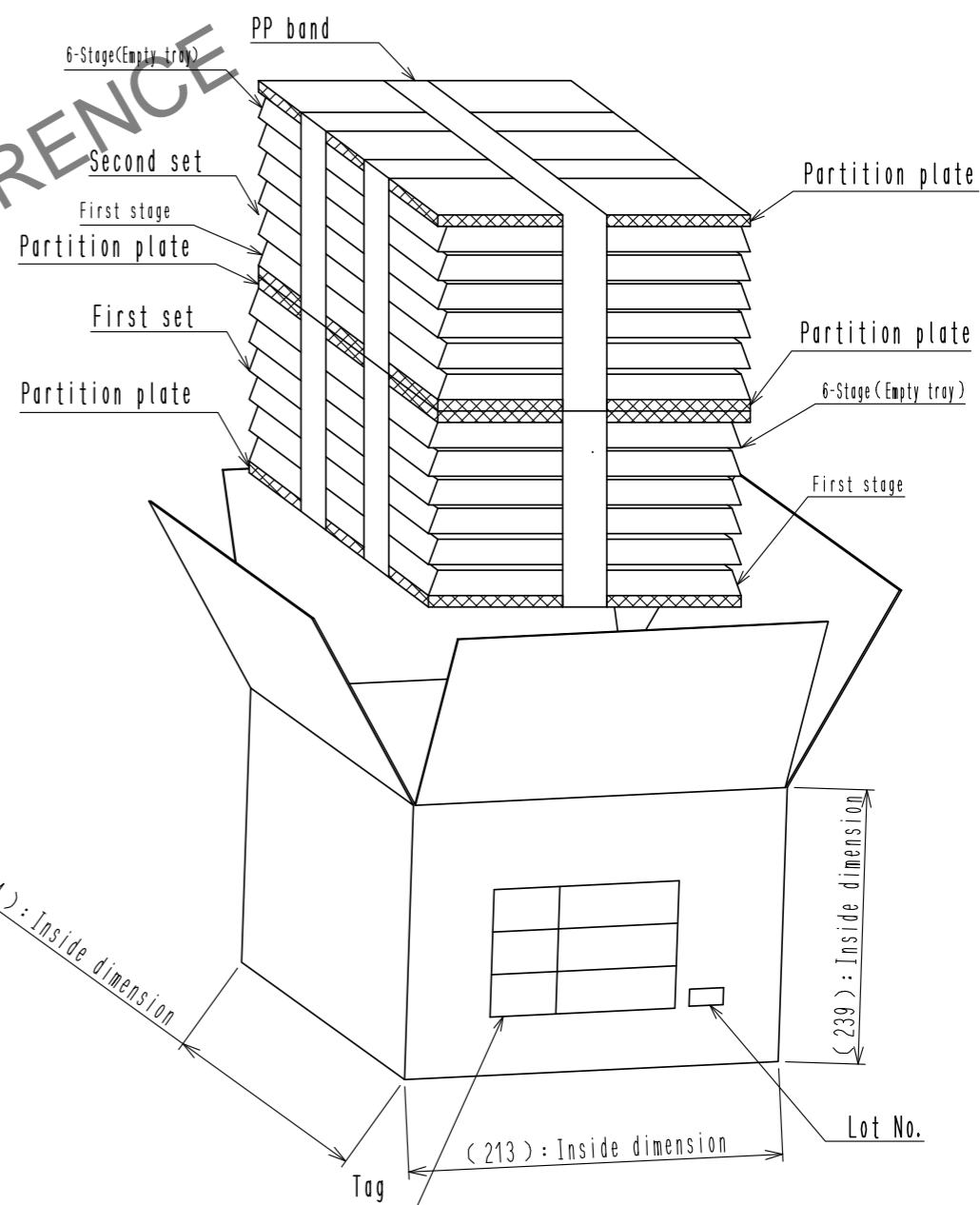


tray B(1:2)



Packing style

- ① Put the connector on the tray A and tray B.
- ② Stack tray A and tray B staggered. Top tray is empty.  
1tray : 70pcs
- ③ Put two sets of cardboard.  
Cardboard : 700pcs



<b>HRS</b>	DRAWING NO.	EDC-377150-00-00	2/2
	PART NO.	GT43-1P-H(B)	
	CODE NO.	CL753-1013-0-00	